
HN58V65A Series HN58V66A Series

8192-word \times 8-bit Electrically Erasable and Programmable
CMOS ROM

HITACHI

ADE-203-539 (Z)
Preliminary
Rev. 0.0
Mar. 18, 1996

Description

The Hitachi HN58V65A series and HN58V66A series are a electrically erasable and programmable EEPROM's organized as 8192-word \times 8-bit. Employing advanced MNOS memory technology and CMOS process and circuitry technology. They also have a 32-byte page programming function to make their write operations faster.

Features

- Single 2.7 to 5.5 V supply
- On-chip latches: address, data, $\overline{\text{CE}}$, $\overline{\text{OE}}$, $\overline{\text{WE}}$
- Automatic byte write: 10 ms (max)
- Automatic page write (32 bytes): 10 ms (max)
- Fast access time: 100 ns (max)
- Low power dissipation: active: 20 mW/MHz (typ)
standby: 110 μ W (max)
- Ready/ $\overline{\text{Busy}}$
- Data polling and Toggle bit
- Data protection circuit on power on/off
- Conforms to JEDEC byte-wide standard
- Reliable CMOS with MNOS cell technology

Preliminary: This document contains information on a new product. Specifications and information contained herein are subject to change notice.



HN58V65A Series, HN58V66A Series

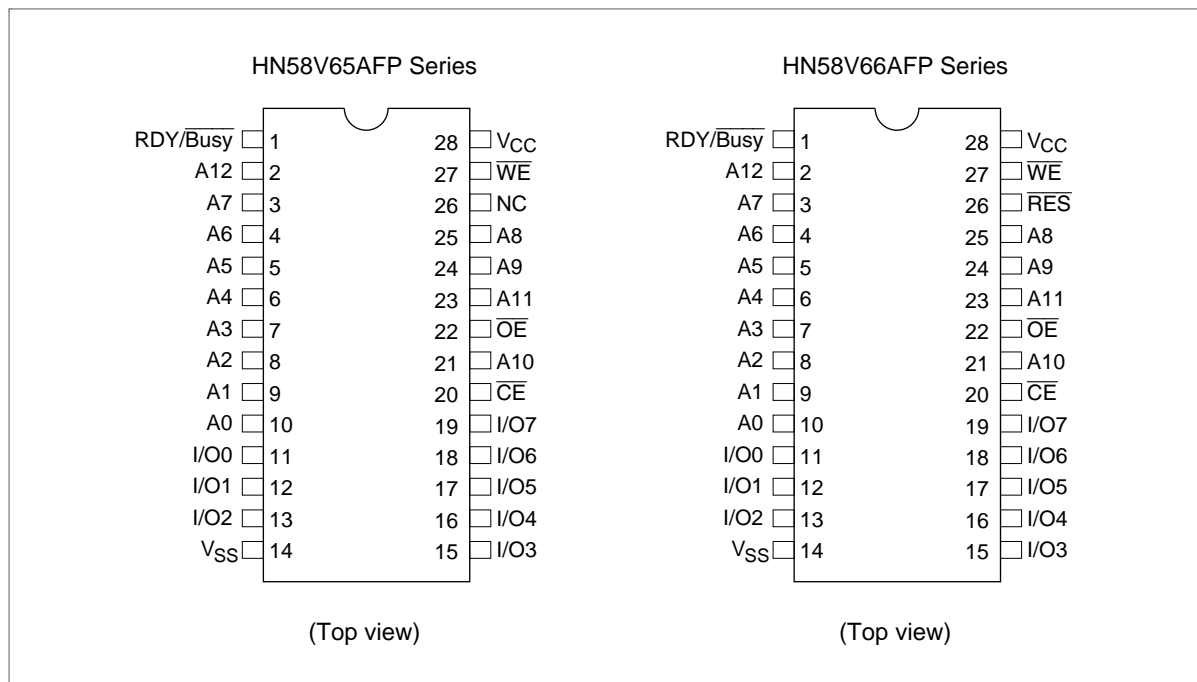
Features (cont)

- 10^5 erase/write cycles (in page mode)
- 10 years data retention
- Software data protection
- Write protection by RES pin (only the HN58V66A series)
- Industrial versions (Temperature range: -20 to 85°C and -40 to 85°C) are also available.

Ordering Information

| Type No. | Access time | Package |
|---------------|-------------|---|
| HN58V65AFP-10 | 100 ns | 400 mil 28-pin plastic SOP (FP-28D/DA) |
| HN58V66AFP-10 | 100 ns | |
| HN58V65ATP-10 | 100 ns | 28-pin plastic TSOP(TFP-28DB) |
| HN58V66ATP-10 | 100 ns | |
| HN58V66AT-10 | 100 ns | 8 × 14 mm 32-pin plastic TSOP(TFP-32DA) |

Pin Arrangement

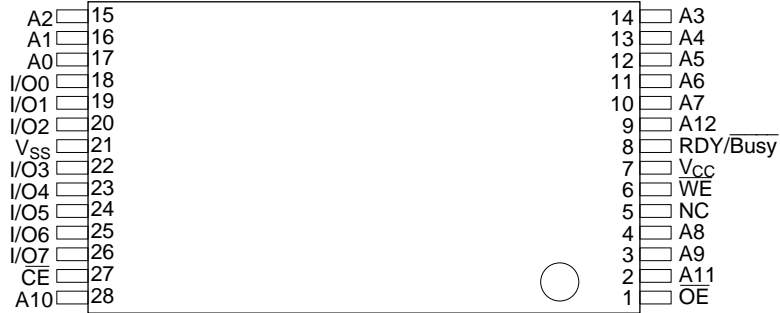


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Pin Arrangement (cont)

HN58V65ATP Series



(Top view)

HN58V66ATP Series



(Top view)

HN58V66AT Series



(Top view)

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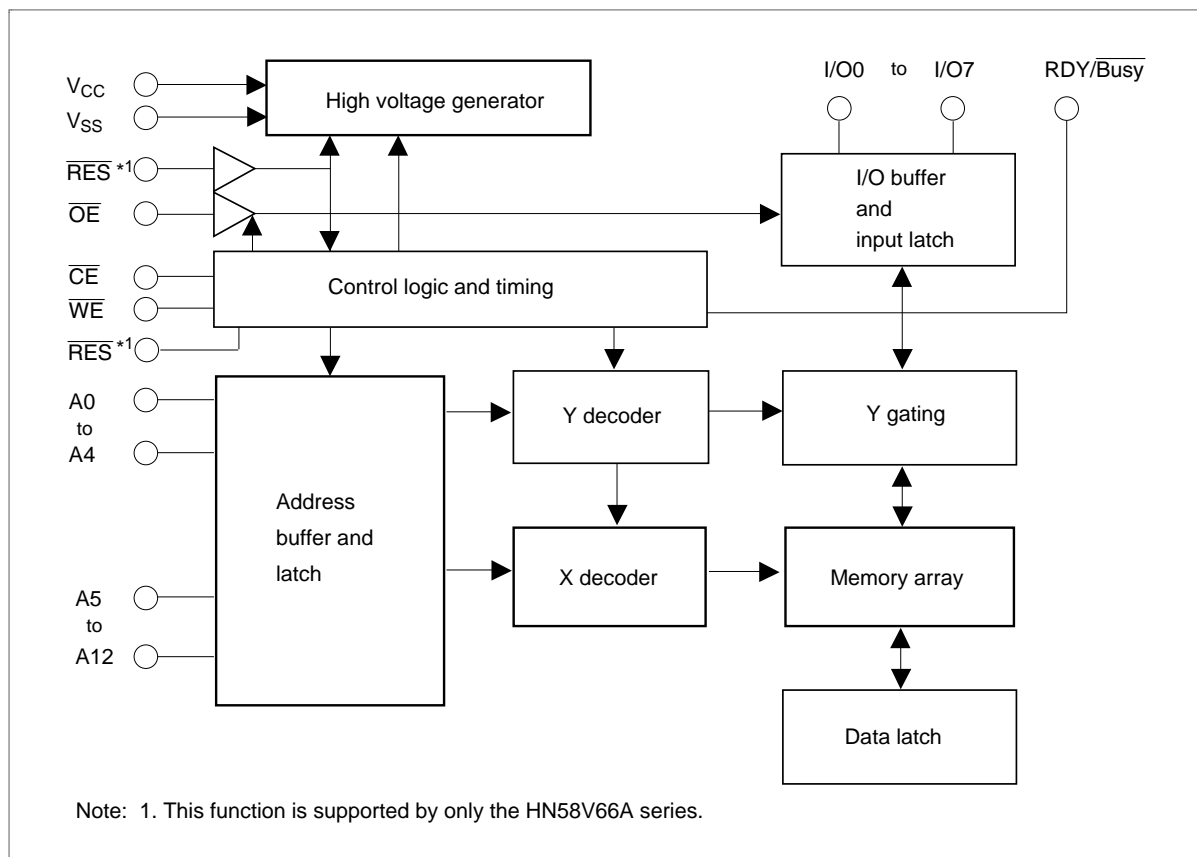
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Pin Description

| Pin name | Function |
|------------------------|-------------------|
| A0 to A12 | Address input |
| I/O0 to I/O7 | Data input/output |
| \overline{OE} | Output enable |
| \overline{CE} | Chip enable |
| \overline{WE} | Write enable |
| V_{CC} | Power supply |
| V_{SS} | Ground |
| RDY/ \overline{Busy} | Ready busy |
| \overline{RES}^{*1} | Reset |
| NC | No connection |

Notes: 1. This function is supported by only the HN58V66A series.

Block Diagram



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Mode Selection

| Pin mode | \overline{CE} | \overline{OE} | \overline{WE} | \overline{RES}^{*3} | $\overline{RDY/Busy}$ | I/O |
|---------------|-----------------|-----------------|-----------------|-----------------------|-----------------------|-----------------|
| Read | V_{IL} | V_{IL} | V_{IH} | V_H^{*1} | High-Z | Dout |
| Standby | V_{IH} | \times^{*2} | \times | \times | High-Z | High-Z |
| Write | V_{IL} | V_{IH} | V_{IL} | V_H | High-Z to V_{OL} | Din |
| Deselect | V_{IL} | V_{IH} | V_{IH} | V_H | High-Z | High-Z |
| Write Inhibit | \times | \times | V_{IH} | \times | — | — |
| | \times | V_{IL} | \times | \times | — | — |
| Data Polling | V_{IL} | V_{IL} | V_{IH} | V_H | V_{OL} | Data out (I/O7) |
| Program reset | \times | \times | \times | V_{IL} | High-Z | High-Z |

- Notes: 1. Refer to the recommended DC operating conditions.
 2. \times : Don't care
 3. This function supported by only the HN58V66A series.

Absolute Maximum Ratings

| Parameter | Symbol | Value | Unit |
|---|-----------|--|------|
| Supply voltage ^{*1} | V_{CC} | −0.6 to +7.0 | V |
| Input voltage ^{*1} | V_{in} | −0.5 ^{*2} to +7.0 ^{*4} | V |
| Operating temperature range ^{*3} | T_{opr} | 0 to +70 | °C |
| Storage temperature range | T_{stg} | −55 to +125 | °C |

- Notes: 1. With respect to V_{SS} .
 2. V_{in} min : −3.0 V for pulse width ≤ 50 ns.
 3. Including electrical characteristics and data retention.
 4. Should not exceed $V_{CC} + 1$ V.

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Recommended DC Operating Conditions

| Parameter | Symbol | Min | Typ | Max | Unit |
|-----------------------|------------|----------------|-----|---------------------|------|
| Supply voltage | V_{CC} | 2.7 | 3.0 | 5.5 | V |
| Input voltage | V_{IL} | -0.3^{*1} | — | 0.6 | V |
| | V_{IH} | 1.9^{*2} | — | $V_{CC} + 0.3^{*3}$ | V |
| | V_H^{*4} | $V_{CC} - 0.5$ | — | $V_{CC} + 1.0$ | V |
| Operating temperature | T_{opr} | 0 | — | 70 | °C |

Notes: 1. V_{IL} min: -1.0 V for pulse width ≤ 50 ns.
2. $V_{IH} = 2.4$ V for $V_{CC} = 3.6$ to 5.5 V.
3. V_{IH} max: $V_{CC} + 1.0$ V for pulse width ≤ 50 ns.
4. This function is supported by only the HN58V66A series.

DC Characteristics ($T_a = 0$ to $+70^\circ\text{C}$, $V_{CC} = 2.7$ to 5.5 V)

| Parameter | Symbol | Min | Typ | Max | Unit | Test conditions |
|----------------------------|-----------|------------------|-----|----------|---------------|---|
| Input leakage current | I_{LI} | — | — | 2^{*1} | μA | $V_{CC} = 5.5$ V, $V_{in} = 5.5$ V |
| Output leakage current | I_{LO} | — | — | 2 | μA | $V_{CC} = 5.5$ V, $V_{out} = 5.5/0.4$ V |
| V_{CC} current (standby) | I_{CC1} | — | — | 20 | μA | $\overline{CE} = V_{CC}$ |
| | I_{CC2} | — | — | 1 | mA | $\overline{CE} = V_{IH}$ |
| V_{CC} current (active) | I_{CC3} | — | — | 6 | mA | $I_{out} = 0$ mA, Duty = 100%, Cycle = 1 μs at $V_{CC} = 3.6$ V |
| | — | — | — | 10 | mA | $I_{out} = 0$ mA, Duty = 100%, Cycle = 1 μs at $V_{CC} = 5.5$ V |
| | — | — | — | 15 | mA | $I_{out} = 0$ mA, Duty = 100%, Cycle = 100 ns at $V_{CC} = 3.6$ V |
| | — | — | — | 25 | mA | $I_{out} = 0$ mA, Duty = 100%, Cycle = 70 ns at $V_{CC} = 5.5$ V |
| Output low voltage | V_{OL} | — | — | 0.4 | V | $I_{OL} = 2.1$ mA |
| Output high voltage | V_{OH} | $V_{CC} \mp 0.8$ | — | — | V | $I_{OH} = -400$ μA |

Note: 1. I_{LI} on RES : 100 μA max (only the HN58V66A series)

Capacitance ($T_a = 25^\circ\text{C}$, $f = 1$ MHz)

| Parameter | Symbol | Min | Typ | Max | Unit | Test conditions |
|--------------------|----------------|-----|-----|-----|------|-----------------|
| Input capacitance | C_{in}^{*1} | — | — | 6 | pF | $V_{in} = 0$ V |
| Output capacitance | C_{out}^{*1} | — | — | 12 | pF | $V_{out} = 0$ V |

Note: 1. This parameter is sampled and not 100% tested.

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AC Characteristics ($T_a = 0$ to $+70^\circ\text{C}$, $V_{CC} = 2.7$ to 5.5 V)

Test Conditions

- Input pulse levels : 0.4 V to 2.4 V ($V_{CC} = 2.7$ to 3.6 V), 0.4 V to 3.0 V ($V_{CC} = 3.6$ to 5.5 V)
 0.4 V to V_{CC} (RES pin*²)
- Input rise and fall time : ≤ 5 ns
- Input timing reference levels : 0.8 , 1.8 V
- Output load : 1TTL Gate +100 pF
- Output reference levels : 1.5 V, 1.5 V

Read Cycle

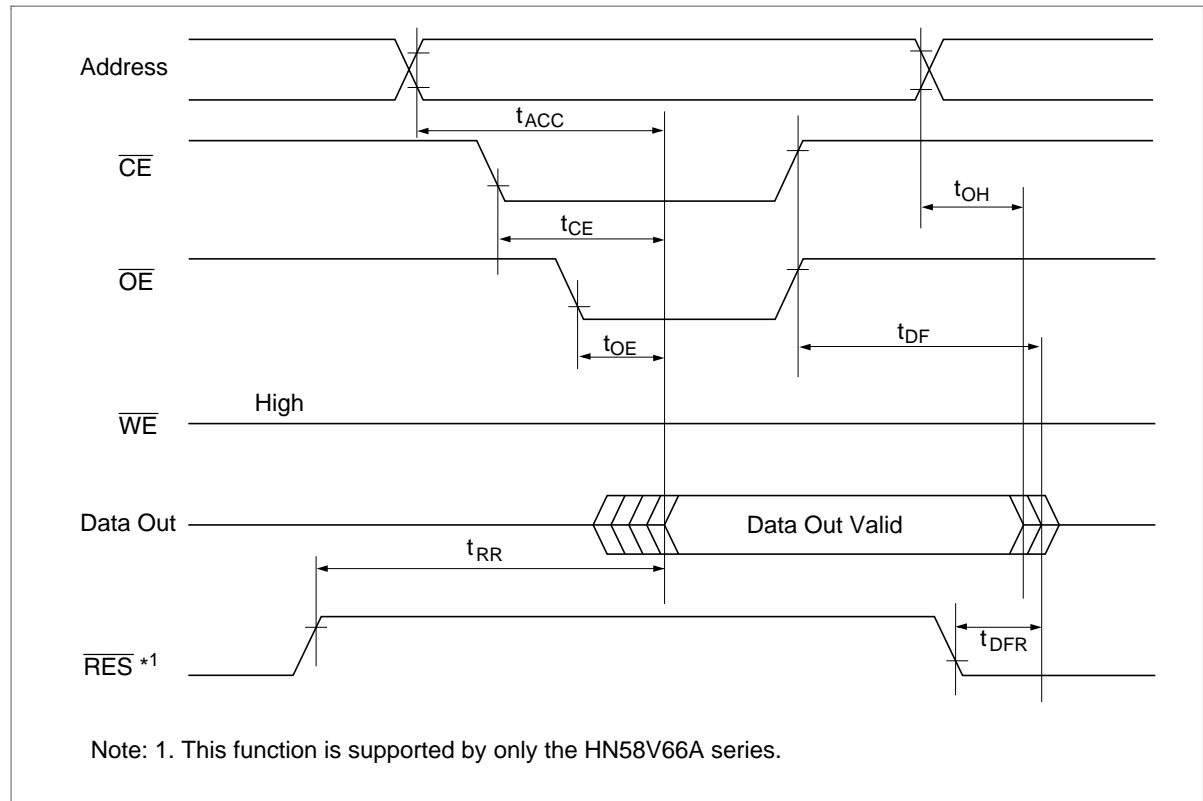
| HN58V65A/HN58V66A | | | | | |
|--|-----------|-----|-----|------|---|
| -10 | | | | | |
| Parameter | Symbol | Min | Max | Unit | Test conditions |
| Address to output delay | t_{ACC} | — | 100 | ns | $\overline{CE} = \overline{OE} = V_{IL}$, $\overline{WE} = V_{IH}$ |
| \overline{CE} to output delay | t_{CE} | — | 100 | ns | $\overline{OE} = V_{IL}$, $\overline{WE} = V_{IH}$ |
| \overline{OE} to output delay | t_{OE} | 10 | 50 | ns | $\overline{CE} = V_{IL}$, $\overline{WE} = V_{IH}$ |
| Address to output hold | t_{OH} | 0 | — | ns | $\overline{CE} = \overline{OE} = V_{IL}$, $\overline{WE} = V_{IH}$ |
| \overline{OE} (\overline{CE}) high to output float* ¹ | t_{DF} | 0 | 40 | ns | $\overline{CE} = V_{IL}$, $\overline{WE} = V_{IH}$ |
| \overline{RES} low to output float* ^{1,2} | t_{DFR} | 0 | 350 | ns | $\overline{CE} = \overline{OE} = V_{IL}$, $\overline{WE} = V_{IH}$ |
| \overline{RES} to output delay* ² | t_{RR} | 0 | 450 | ns | $\overline{CE} = \overline{OE} = V_{IL}$, $\overline{WE} = V_{IH}$ |

Notes: 1. t_{DF} and t_{DFR} are defined as the time at which the outputs achieve the open circuit conditions and are no longer driven.

2. This function is supported by only the HN58V66A series.

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Read Timing Waveform



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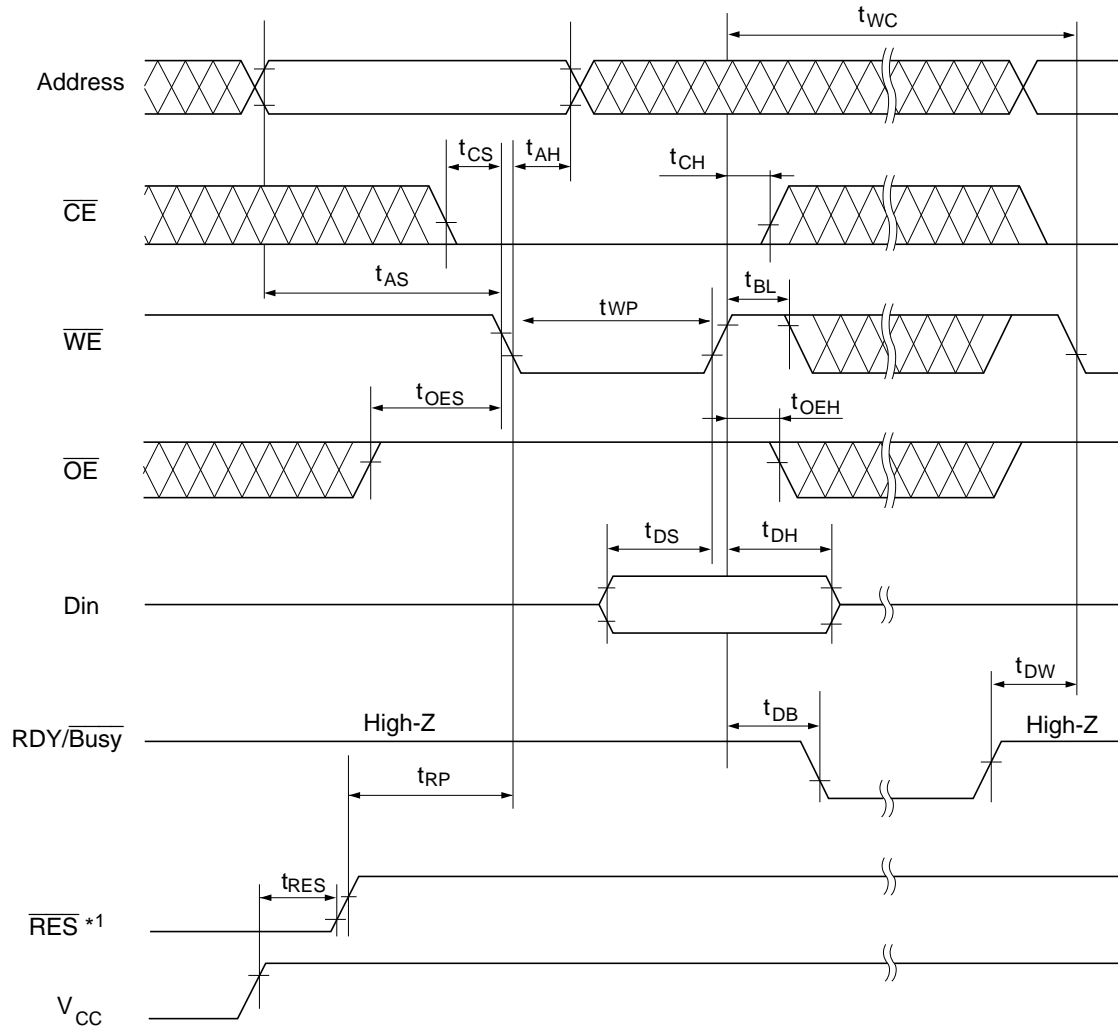
Write Cycle

| Parameter | Symbol | Min* ¹ | Typ | Max | Unit | Test conditions |
|---|-----------|-------------------|-----|-----------|---------|-----------------|
| Address setup time | t_{AS} | 0 | — | — | ns | |
| Address hold time | t_{AH} | 50 | — | — | ns | |
| \overline{CE} to write setup time (\overline{WE} controlled) | t_{CS} | 0 | — | — | ns | |
| \overline{CE} hold time (\overline{WE} controlled) | t_{CH} | 0 | — | — | ns | |
| \overline{WE} to write setup time (\overline{CE} controlled) | t_{WS} | 0 | — | — | ns | |
| \overline{WE} hold time (\overline{CE} controlled) | t_{WH} | 0 | — | — | ns | |
| \overline{OE} to write setup time | t_{OES} | 0 | — | — | ns | |
| \overline{OE} hold time | t_{OEH} | 0 | — | — | ns | |
| Data setup time | t_{DS} | 50 | — | — | ns | |
| Data hold time | t_{DH} | 0 | — | — | ns | |
| \overline{WE} pulse width (\overline{WE} controlled) | t_{WP} | 200 | — | — | ns | |
| \overline{CE} pulse width (\overline{CE} controlled) | t_{CW} | 200 | — | — | ns | |
| Data latch time | t_{DL} | 100 | — | — | ns | |
| Byte load cycle | t_{BLC} | 0.3 | — | 30 | μs | |
| Byte load window | t_{BL} | 100 | — | — | μs | |
| Write cycle time | t_{WC} | — | — | 10^{*2} | ms | |
| Time to device busy | t_{DB} | 120 | — | — | ns | |
| Write start time | t_{DW} | 0^{*3} | — | — | ns | |
| Reset protect time* ⁴ | t_{RP} | 100 | — | — | μs | |
| Reset high time* ^{4, 5} | t_{RES} | 1 | — | — | μs | |

- Notes:
1. Use this device in longer cycle than this value.
 2. t_{WC} must be longer than this value unless polling techniques or RDY/\overline{Busy} are used. This device automatically completes the internal write operation within this value.
 3. Next read or write operation can be initiated after t_{DW} if polling techniques or RDY/\overline{Busy} are used.
 4. This function is supported by only the HN58V66A series.
 5. This parameter is sampled and not 100% tested.

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Byte Write Timing Waveform(1) ($\overline{\text{WE}}$ Controlled)

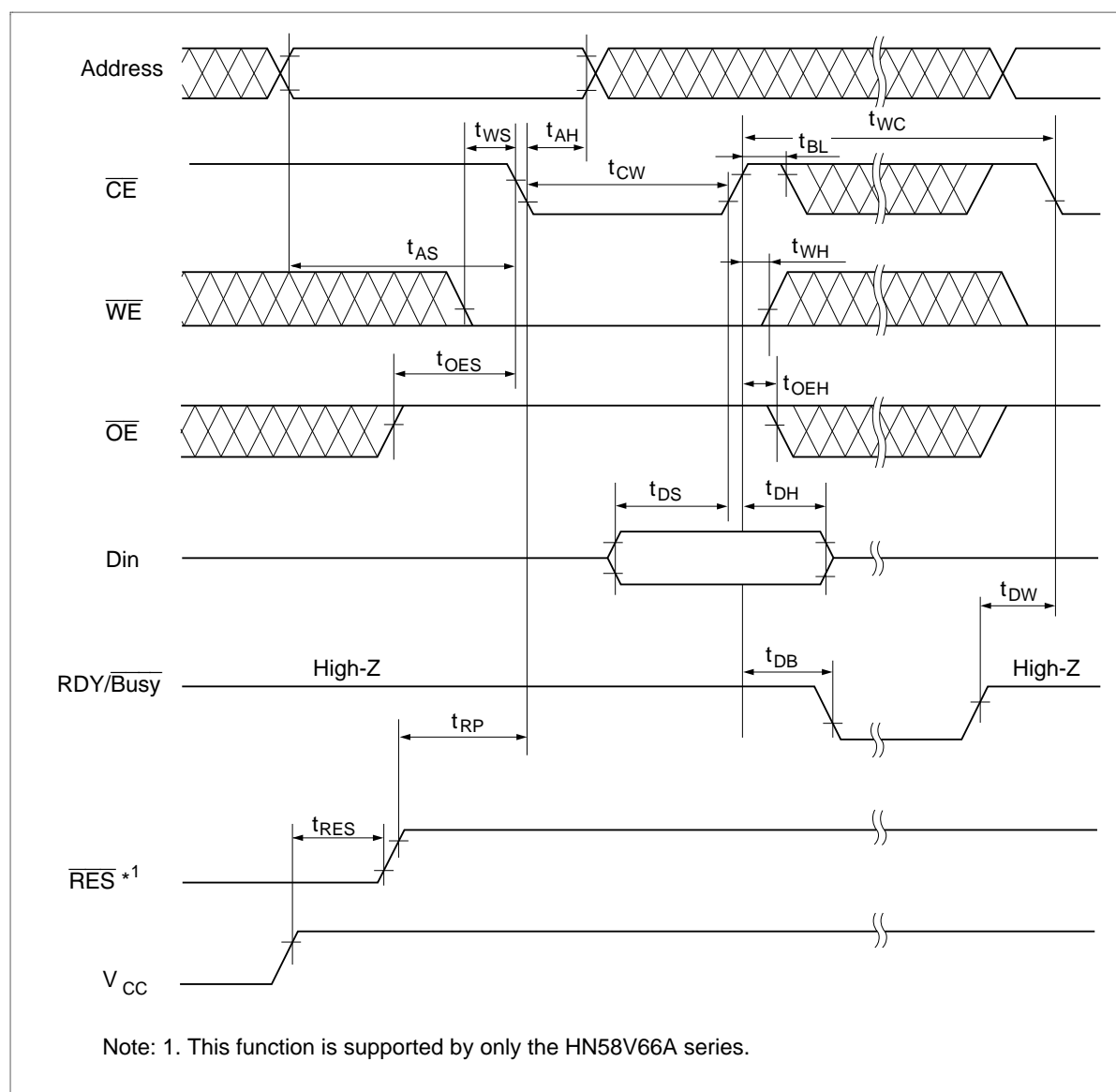


Note: 1. This function is supported by only the HN58V66A series.

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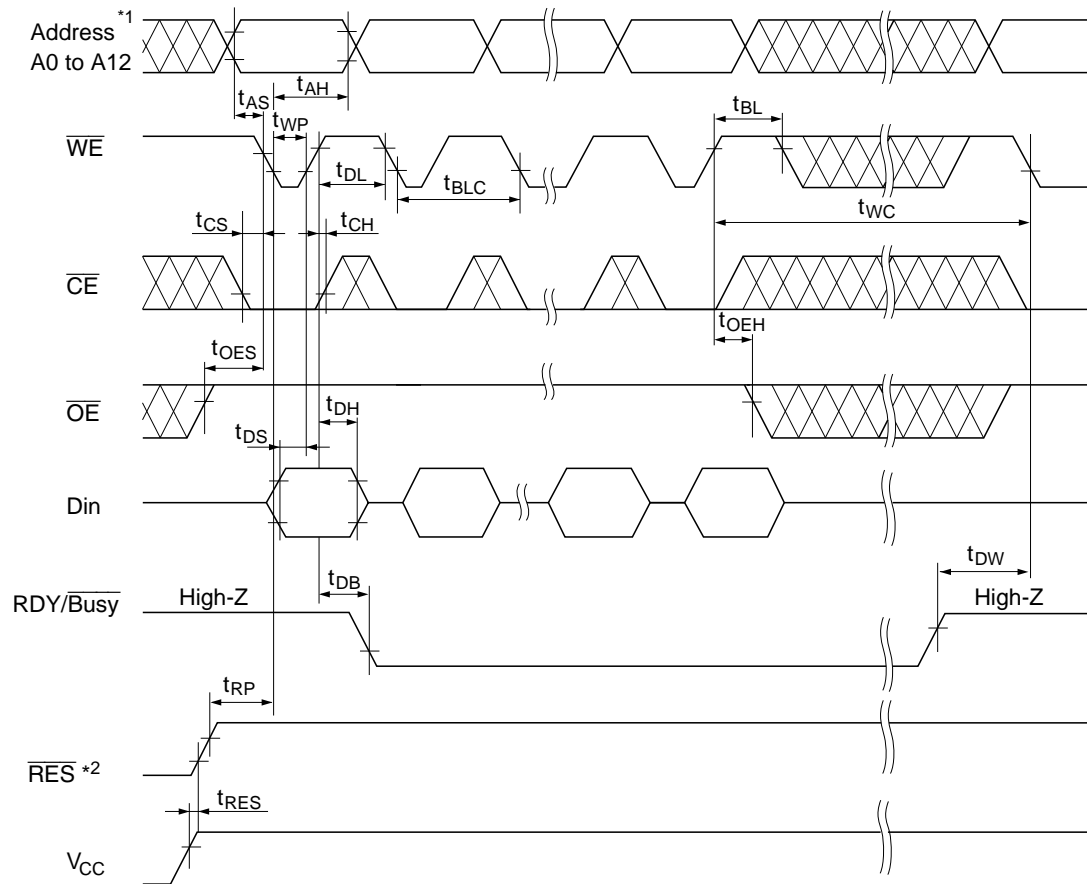
HN58V65A Series, HN58V66A Series

Byte Write Timing Waveform(2) ($\overline{\text{CE}}$ Controlled)



HN58V65A Series, HN58V66A Series

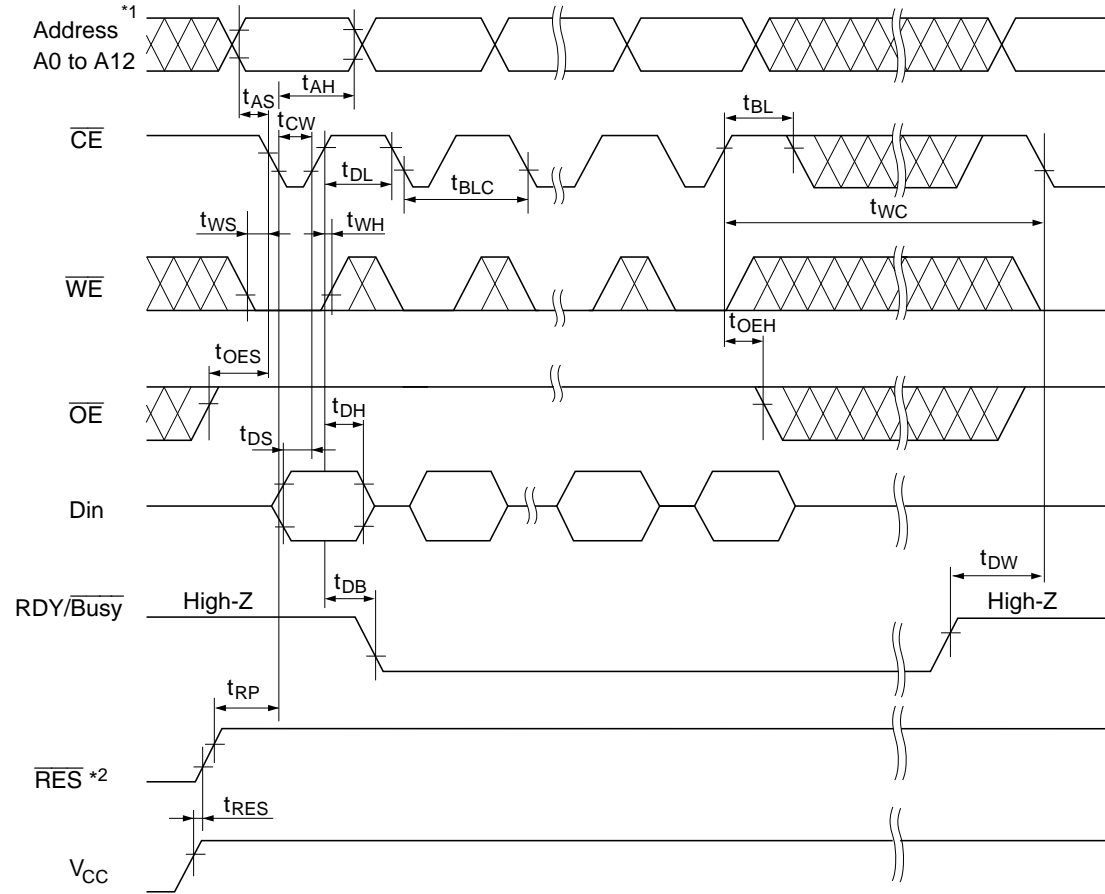
Page Write Timing Waveform(1) ($\overline{\text{WE}}$ Controlled)



Notes: 1. A5 through A12 are page address and these address are latched at the first falling edge of $\overline{\text{WE}}$
 @ @ @ 2. This function is supported by only the HN58V66A series.

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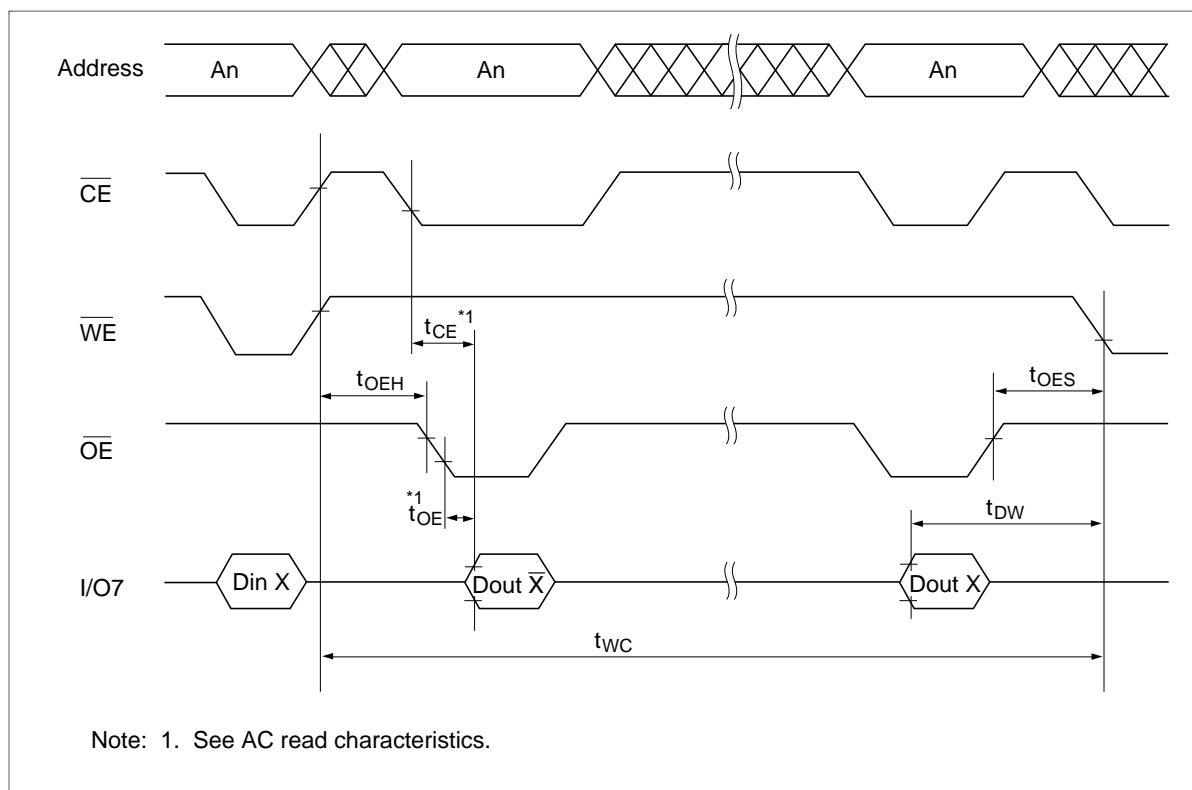
Page Write Timing Waveform(2) ($\overline{\text{CE}}$ Controlled)



Notes: 1. A5 through A12 are page address and these address are latched at the first falling edge of $\overline{\text{CE}}$
 @ @ @ 2. This function is supported by only the HN58V66A series.

HN58V65A Series, HN58V66A Series

Data Polling Timing Waveform

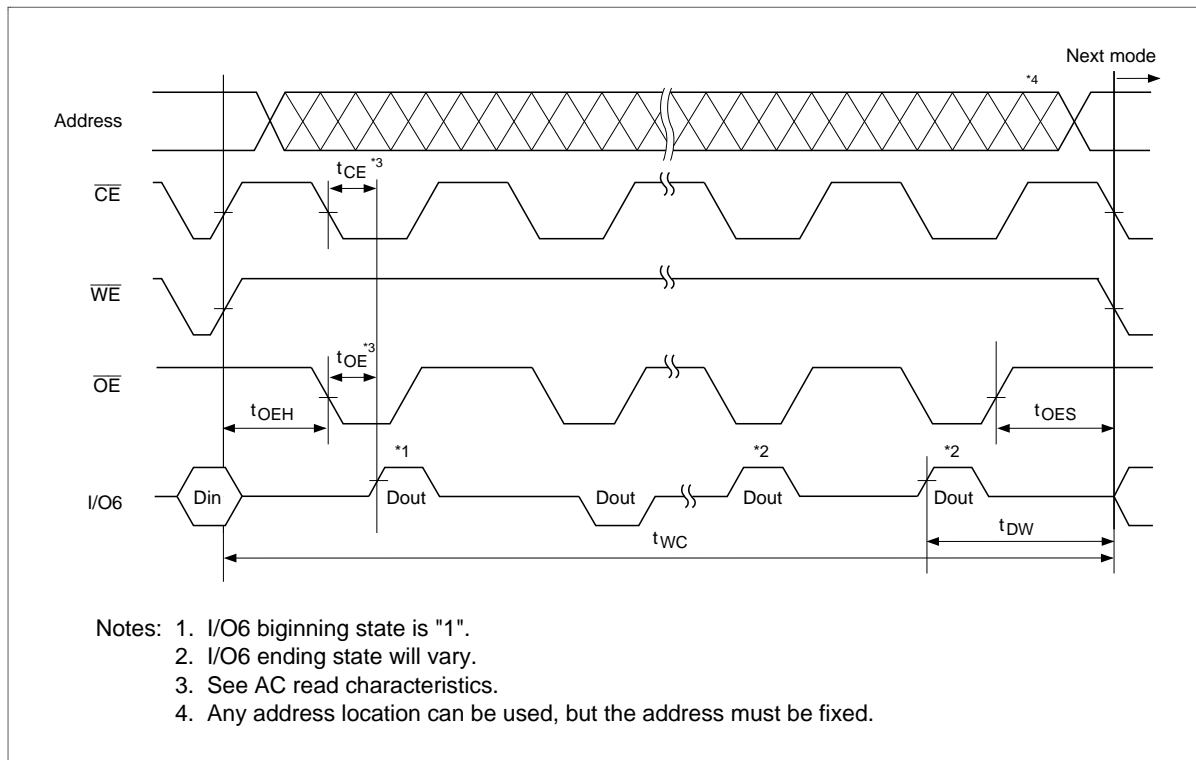


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Toggle Bit

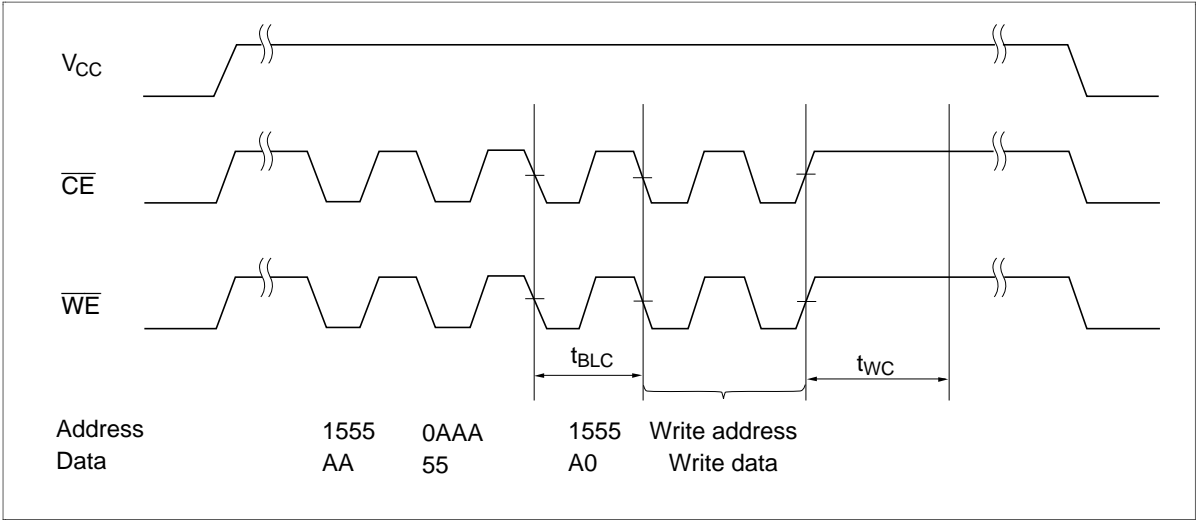
This device provides another function to determine the internal programming cycle. If the EEPROM is set to read mode during the internal programming cycle, I/O6 will change from „1“ to „0“ (toggling) for each read. When the internal programming cycle is finished, toggling of I/O6 will stop and the device can be accessible for next read or program.

Toggle Bit Waveform

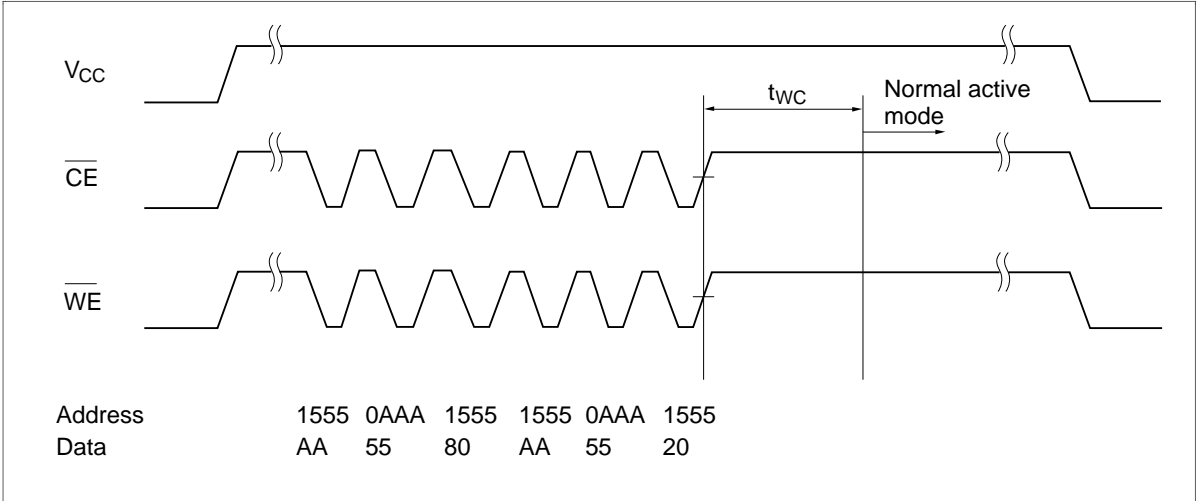


HN58V65A Series, HN58V66A Series

Software Data Protection Timing Waveform(1) (in protection mode)



Software Data Protection Timing Waveform(2) (in non-protection mode)



Functional Description

Automatic Page Write

Page-mode write feature allows 1 to 32 bytes of data to be written into the EEPROM in a single write cycle. Following the initial byte cycle, an additional 1 to 31 bytes can be written in the same manner. Each additional byte load cycle must be started within 30 μ s from the preceding falling edge of \overline{WE} or \overline{CE} . When \overline{CE} or \overline{WE} is kept high for 100 μ s after data input, the EEPROM enters write mode automatically and the input data are written into the EEPROM.

Data Polling

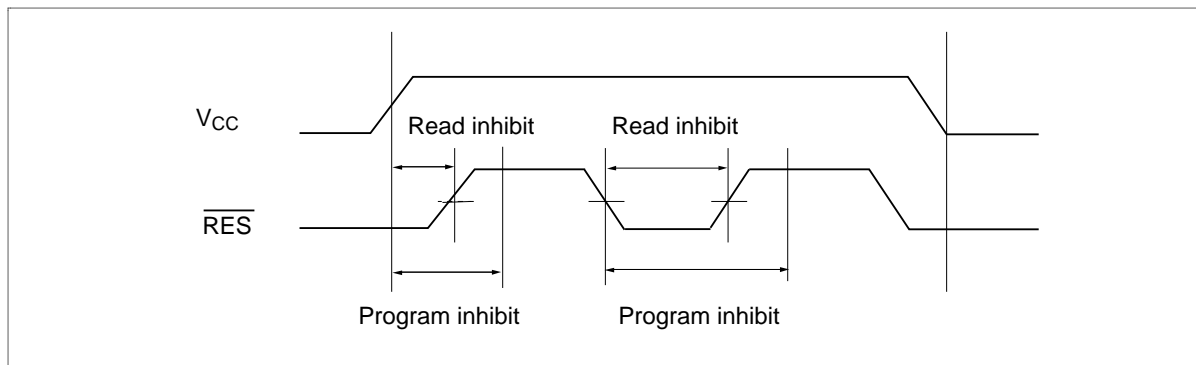
Data polling allows the status of the EEPROM to be determined. If EEPROM is set to read mode during a write cycle, an inversion of the last byte of data to be loaded outputs from I/O7 to indicate that the EEPROM is performing a write operation.

RDY/Busy Signal

RDY/Busy signal also allows status of the EEPROM to be determined. The RDY/Busy signal has high impedance except in write cycle and is lowered to V_{OL} after the first write signal. At the end of a write cycle, the RDY/Busy signal changes state to high impedance.

\overline{RES} Signal (only the HN58V66A series)

When \overline{RES} is low, the EEPROM cannot be read or programmed. Therefore, data can be protected by keeping \overline{RES} low when V_{CC} is switched. \overline{RES} should be high during read and programming because it doesn't provide a latch function.



HN58V65A Series, HN58V66A Series

$\overline{\text{WE}}$, $\overline{\text{CE}}$ Pin Operation

During a write cycle, addresses are latched by the falling edge of $\overline{\text{WE}}$ or $\overline{\text{CE}}$, and data is latched by the rising edge of $\overline{\text{WE}}$ or $\overline{\text{CE}}$.

Write/Erase Endurance and Data Retention Time

The endurance is 10^5 cycles in case of the page programming and 10^4 cycles in case of the byte programming (1% cumulative failure rate). The data retention time is more than 10 years when a device is page-programmed less than 10^4 cycles.

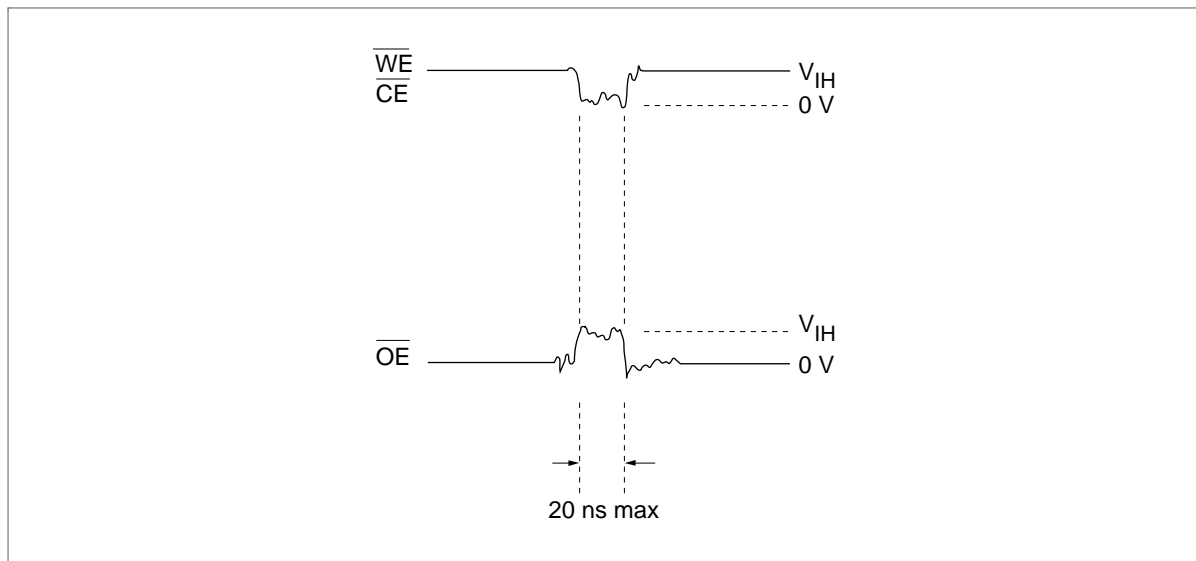
Data Protection

1. Data Protection against Noise on Control Pins ($\overline{\text{CE}}$, $\overline{\text{OE}}$, $\overline{\text{WE}}$) during Operation

During readout or standby, noise on the control pins may act as a trigger and turn the EEPROM to programming mode by mistake.

To prevent this phenomenon, this device has a noise cancellation function that cuts noise if its width is 20 ns or less in programming mode.

Be careful not to allow noise of a width of more than 20 ns on the control pins.

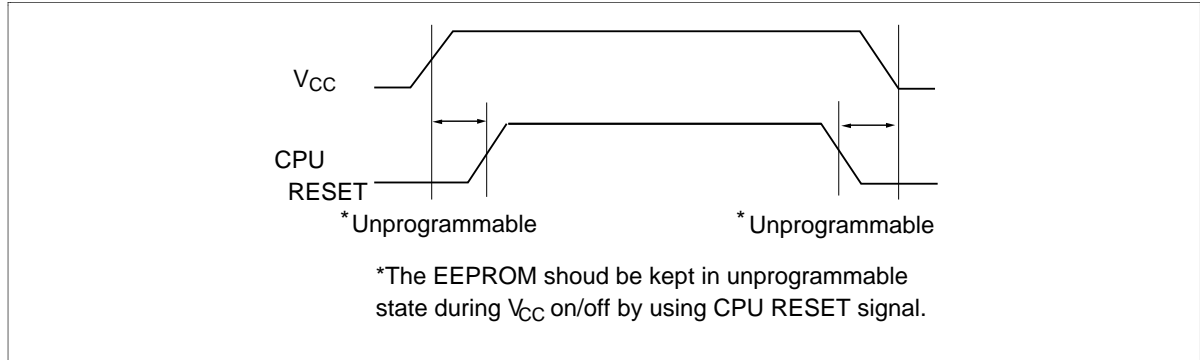


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2. Data protection at V_{CC} on/off

When V_{CC} is turned on or off, noise on the control pins generated by external circuits (CPU, etc) may act as a trigger and turn the EEPROM to program mode by mistake. To prevent this unintentional programming, the EEPROM must be kept in an unprogrammable state while the CPU is in an unstable state.



(1) Protection by \overline{CE} , \overline{OE} , \overline{WE}

To realize the unprogrammable state, the input level of control pins must be held as shown in the table below.

| | | | |
|-----------------|----------|----------|----------|
| \overline{CE} | V_{CC} | \times | \times |
| \overline{OE} | \times | V_{SS} | \times |
| \overline{WE} | \times | \times | V_{CC} |

\times : Don't care.

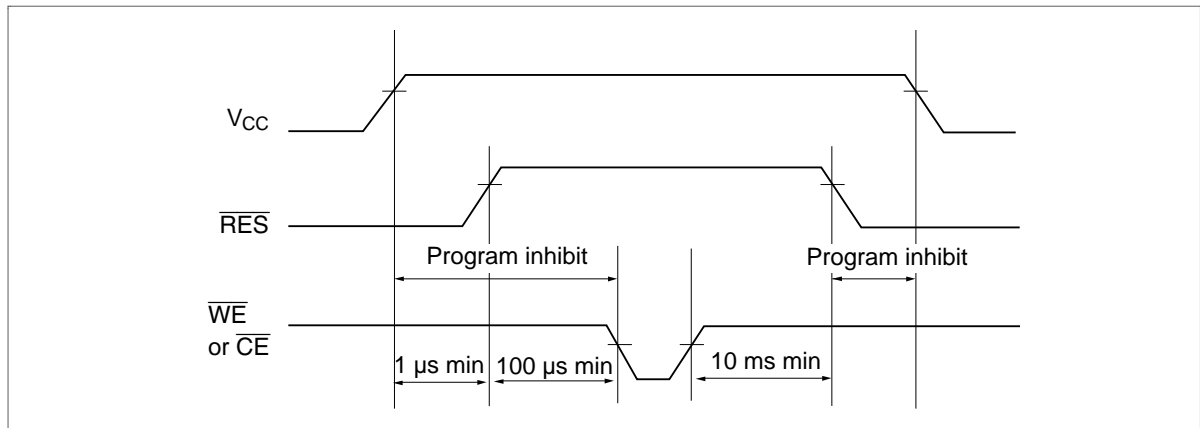
V_{CC} : Pull-up to V_{CC} level.

V_{SS} : Pull-down to V_{SS} level.

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(2) Protection by $\overline{\text{RES}}$ (only the HN58V66A series)

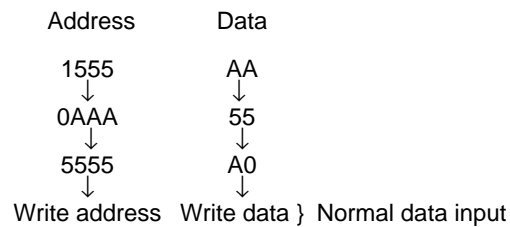
The unprogrammable state can be realized by that the CPU's reset signal inputs directly to the EEPROM's $\overline{\text{RES}}$ pin. $\overline{\text{RES}}$ should be kept V_{SS} level during V_{CC} on/off. The EEPROM breaks off programming operation when $\overline{\text{RES}}$ becomes low, programming operation doesn't finish correctly in case that $\overline{\text{RES}}$ falls low during programming operation. $\overline{\text{RES}}$ should be kept high for 10 ms after the last data input.



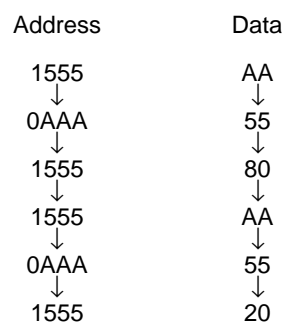
HN58V65A Series, HN58V66A Series

3. Software data protection

To prevent unintentional programming caused by noise generated by external circuits, this device has the software data protection function. In software data protection mode, 3 bytes of data must be input before write data as follows. And these bytes can switch the non-protection mode to the protection mode.



Software data protection mode can be cancelled by inputting the following 6 bytes. After that, this device turns to the non-protection mode and can write data normally. But when the data is input in the cancelling cycle, the data cannot be written.



The software data protection is not enabled at the shipment.

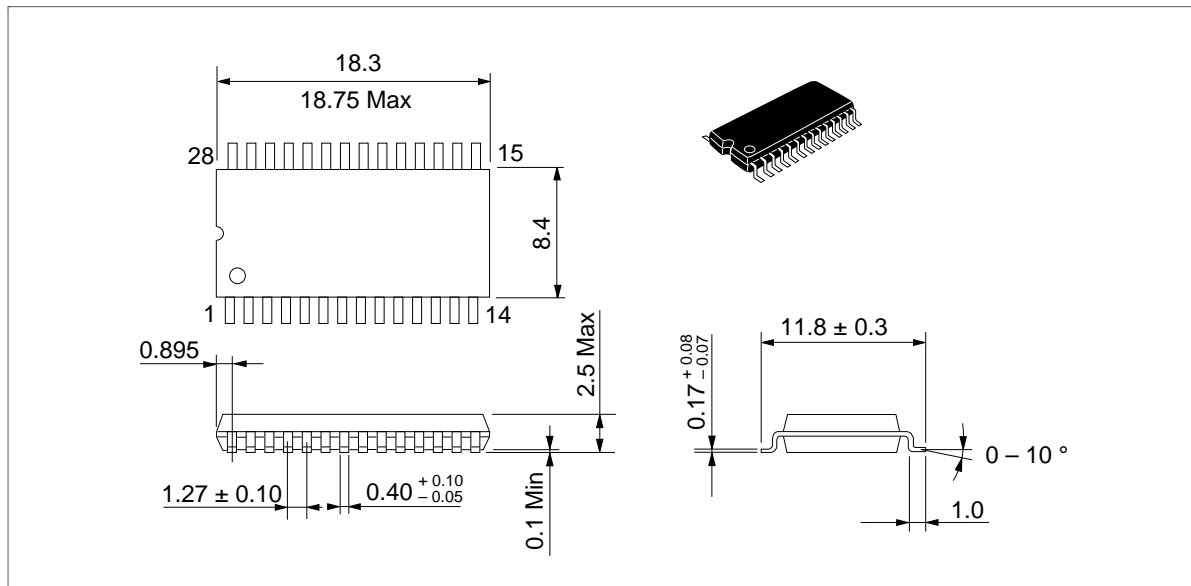
HN58V65A Series, HN58V66A Series

Package Dimensions

HN58V65AFP Series

HN58V66AFP Series (FP-28D)

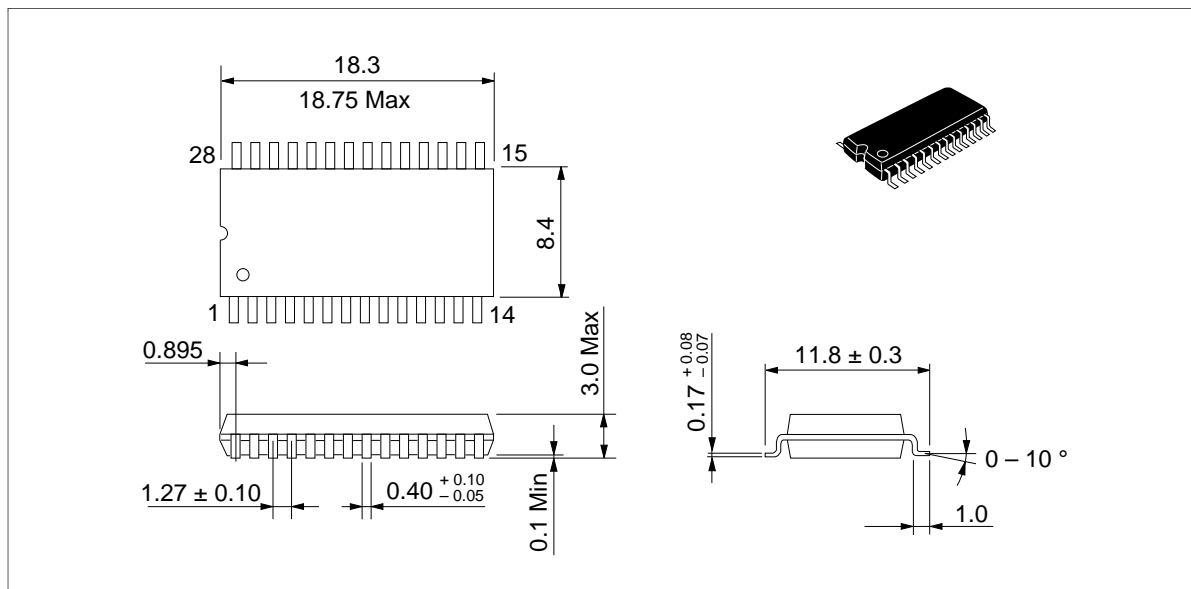
Unit : mm



HN58V65AFP Series

HN58V66AFP Series (FP-28DA)

Unit : mm



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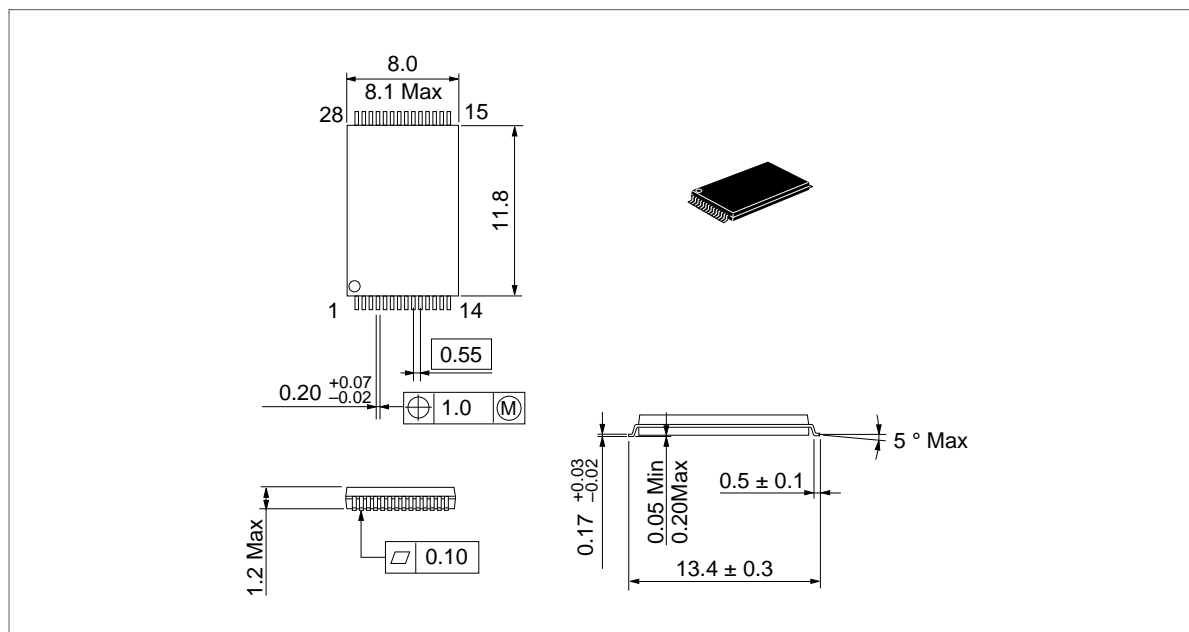
HN58V65A Series, HN58V66A Series

Package Dimensions (cont)

HN58V65ATP Series

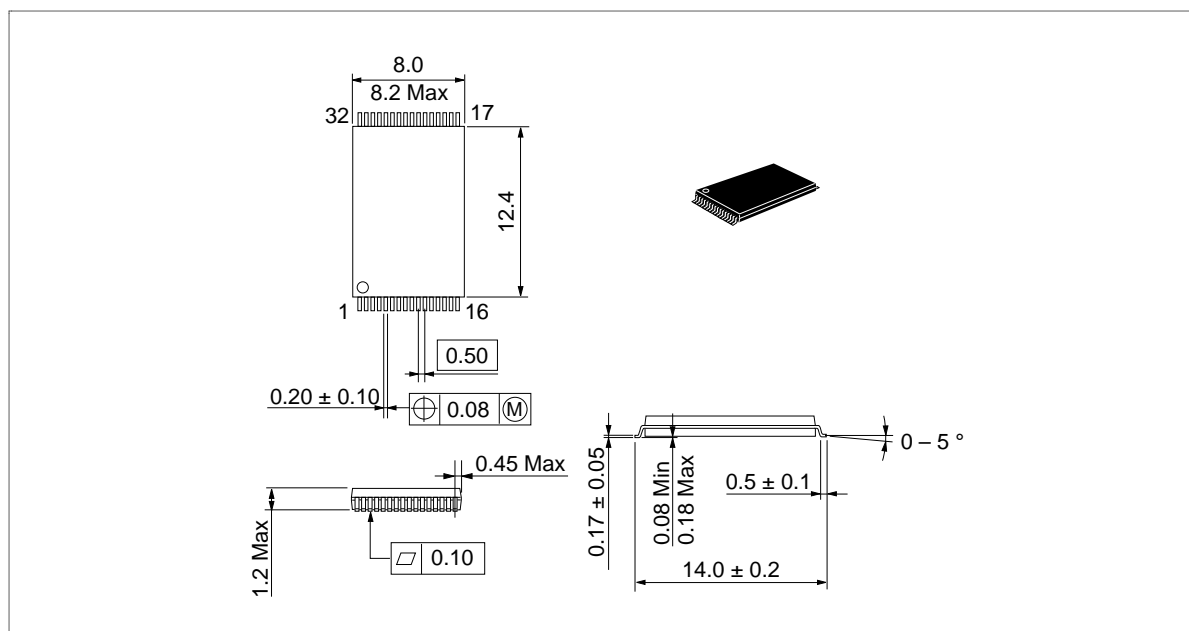
HN58V66ATP Series (TFP-28DB)

Unit : mm



HN58V66AT Series (TFP-32DA)

Unit : mm



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Revision Record

| Rev. | Date | Contents of Modification | Drawn by | Approved by |
|------|---------------|--------------------------|----------|-------------|
| 0.0 | Mar. 18, 1995 | Initial issue | | |